

Philips

Diode BYG90-20

Datasheet

Silicon Schottky Diode

BYG90-20

20V/1A

DATASHEET

OEM – Philips

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Schottky barrier rectifier diodes**BYG90-40 series****FEATURES**

- Low switching losses
- Capability of absorbing very high surge current
- Fast recovery time
- Guard ring protected
- Plastic SMD package.

APPLICATIONS

- Low power switched-mode power supplies
- Rectifying
- Polarity protection.

DESCRIPTION

The BYG 90-40 series consists of Schottky barrier rectifier diodes, fabricated in planar technology, and encapsulated in rectangular SOD106A plastic SMD packages.

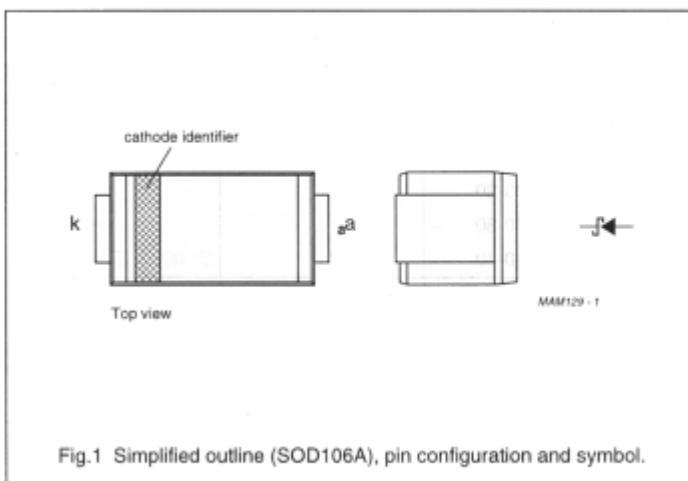


Fig.1 Simplified outline (SOD106A), pin configuration and symbol.

Schottky barrier rectifier diodes

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per diode					
V_R	continuous reverse voltage BYG90-20 BYG90-30 BYG90-40		-	20 30 40	V
V_{RRM}	repetitive peak reverse voltage BYG90-20 BYG90-30 BYG90-40		-	20 30 40	V
V_{RWM}	crest working reverse voltage BYG90-20 BYG90-30 BYG90-40		-	20 30 40	V
$I_{F(AV)}$	average forward current	$T_{amb} = 65^{\circ}\text{C}$; see Fig.2; $R_{th\ j-a} = 80 \text{ K/W}$; note 1; $V_R(\text{equiv}) = 0.2 \text{ V}$; note 2	-	1	A
I_{FSM}	non-repetitive peak forward current	$t = 8.3 \mu\text{s}$ half sine wave; JEDEC method	-	30	A
I_{RSM}	non-repetitive peak reverse current	$t_p = 100 \mu\text{s}$	-	0.5	A
T_{stg}	storage temperature		-65	+125	$^{\circ}\text{C}$
T_j	junction temperature		-	125	$^{\circ}\text{C}$

Notes

1. Refer to SOD106A standard mounting conditions.
2. For Schottky barrier diodes thermal run-away has to be considered, as in some applications, the reverse power losses P_R are a significant part of the total power losses. Nomograms for determination of the reverse power losses P_R and $I_{F(AV)}$ rating will be available on request.

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ELECTRICAL CHARACTERISTICS $T_{amb} = 25 \text{ }^{\circ}\text{C}$; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Per diode						
V_F	forward voltage	see Fig.2; note 1 $I_F = 1 \text{ A}$ $I_F = 3 \text{ A}$ $I_F = 1 \text{ A}; T_j = 100 \text{ }^{\circ}\text{C}$	—	—	550	mV
I_R	reverse current	$V_R = V_{RRMmax}$; note 1; see Fig.3 $V_R = V_{RRMmax}; T_j = 100 \text{ }^{\circ}\text{C}$; note 1; see Fig.3	—	—	10	mA
C_d	diode capacitance	$V_R = 4 \text{ V}; f = 1 \text{ MHz}$; see Fig.4	—	—	75	pF

Note

1. Pulsed test: $t_p = 300 \mu\text{s}$; $\delta = 0.02$.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th j-a}$	thermal resistance from junction to ambient	note 1	80	K/W

Note

1. Refer to SOD106A standard mounting conditions.

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GRAPHICAL DATA

